Shenzhen Leadtek Electronics Co.,Ltd

PRODUCT SPECIFICATION

TFT-LCD MODULE

Module No：LTK042MNHLM14-V0

☑ Preliminary Specification

☐ Approval Specification

Designed by	Checked by	Approved by
		

Final Approval by Customer

Approved by	Comment

※The specification of “TBD” should refer to the measured value of sample . If there is difference between the design specification and measured value, we naturally shall negotiate and agree to solution with customer.

1.0 Document Revision History

Version	Contents	Date	Note
V0	Initial version	2023.08.09	

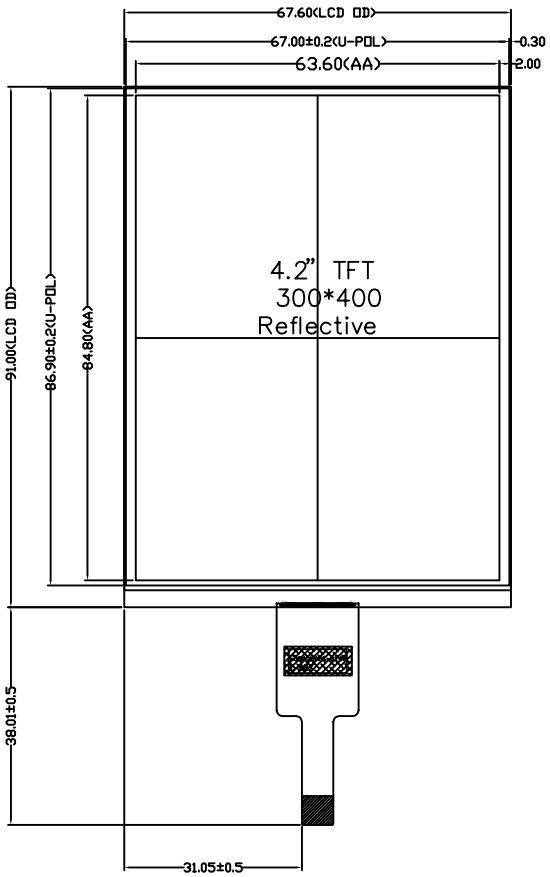
2.General Description

NO	Item	Specification	Unit
1	LCD Size	TFT"4.2	inch
2	Panel Type	TN	mm
3	Display Resolution	300 (H) x 400 (V)	pixel
4	Display Mode	reflective/Normally white	-
5	Viewing Direction	60/60/60/60	-
6	LCM Module size	67.60 (H) x 91.00 (V) x0.72(T)	mm
7	Panel Active Area	63.60 (H) x 84.80(V)	mm
8	Pixel Pitch	0.212 (H) x 0.212 (V)	mm
9	LCM Driver	-	
10	Light Source	White LED	
11	LCM Interface	SPI 4Line	bit

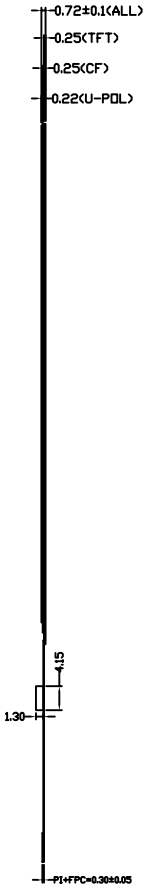
Note : Please refer to the mechanical drawing

3.Mechanical Drawing

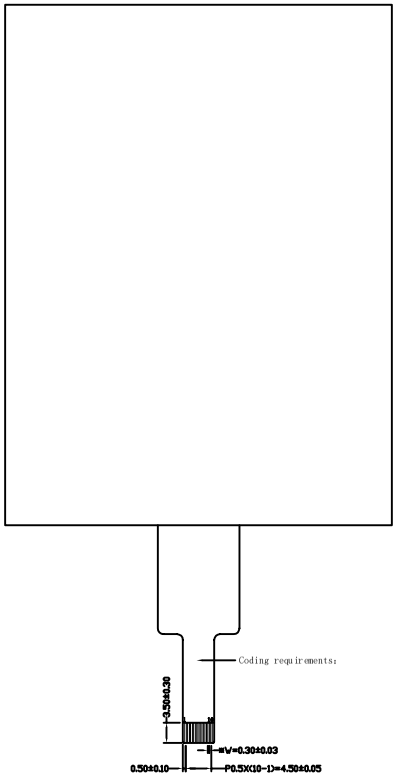
FrontView



Side View



Back View



PIN	SYMBOL
1	GND
2	GND
3	VCC2.8
4	TE
5	NRESET
6	CS
7	WRX
8	DCX
9	SDA
10	GND

Notes:

1. Display : 4.2", TFT
2. Resolution: 300xRGBx400
3. LCD Viewing Direction: 60/60/60/60
4. Drive IC:ST7306
5. Display Mode: Normally White/Reflective/Mono
6. unmark Tolerance:±0.2
7. OPERATING TEMP: -20° C~ +70° C
8. STORAGE TEMP: -30° C~ +80° C
9. Requirements on Environmental Protection: ROHS

REV	DESCRIPTION	DATE	NAME
3			
2			
1			
0	NEW	2023.07.18	IAN

LEADTEK COMPANY LIMITED

SCALE:1/1	UNIT:mm	PAGE:1/1		Approve	Check	Drawn
Part No:	LTK042MNHLM14		VER:V0		JONA	IAN
Customer No:						

4.0 Interface Pin Connection
4.1 TFT LCD Module

Pin No.	Symbol	Description
1	GND	Power Ground
2	GND	Power Ground
3	VCC2.8	Power Supply(Analog). VCI=2.8V-3.3V
4	TE	Serves TE (Tearing Effect) pin on MPU interface.
5	NRESET	Reset signal(low active)
6	CS	Chip select pin
7	SCL(WRX)	Servers as SCL (Serial Clock)
8	A0(DCX)	Data or command select pin
9	SDA	Serial data input pin
10	GND	Power Ground

5. ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Power Supply voltage 1	VCC 2.8	-0.3	+3.3	V
Power Supply voltage 2	VDDI1V8	-0.3	+3.3	V
Operating temperature	TOP	-20	+70	℃
Storage temperature	TST	-30	+80	℃
Humidity	RH	-	90%(Max60℃)	RH

6.ELECTRICAL CHARACTERISTICS

DC CHARACTERISTICS

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage for analog	VCC 2.8	2.6	2.8	3.3	V
Supply voltage for interface I/O	VDD1V8	1.65	--	3.3	V
I/O leakage current	IDD	-	-	TBD	mA
Input voltage 'H'level	VIH	0.7*IOVCC	—	IOVCC	V
Input voltage 'L'level	VIL	0	—	0.3*IOVCC	V
Output voltage 'H'level	VOH	0.8*IOVCC	—	IOVCC	V
Output voltage 'L'level	VOL	0	—	0.2*IOVCC	V

7.0 Power ON/OFF Sequence

VDDI and VDDA can be applied in any order.

VDDA and VDDI can be power down in any order.

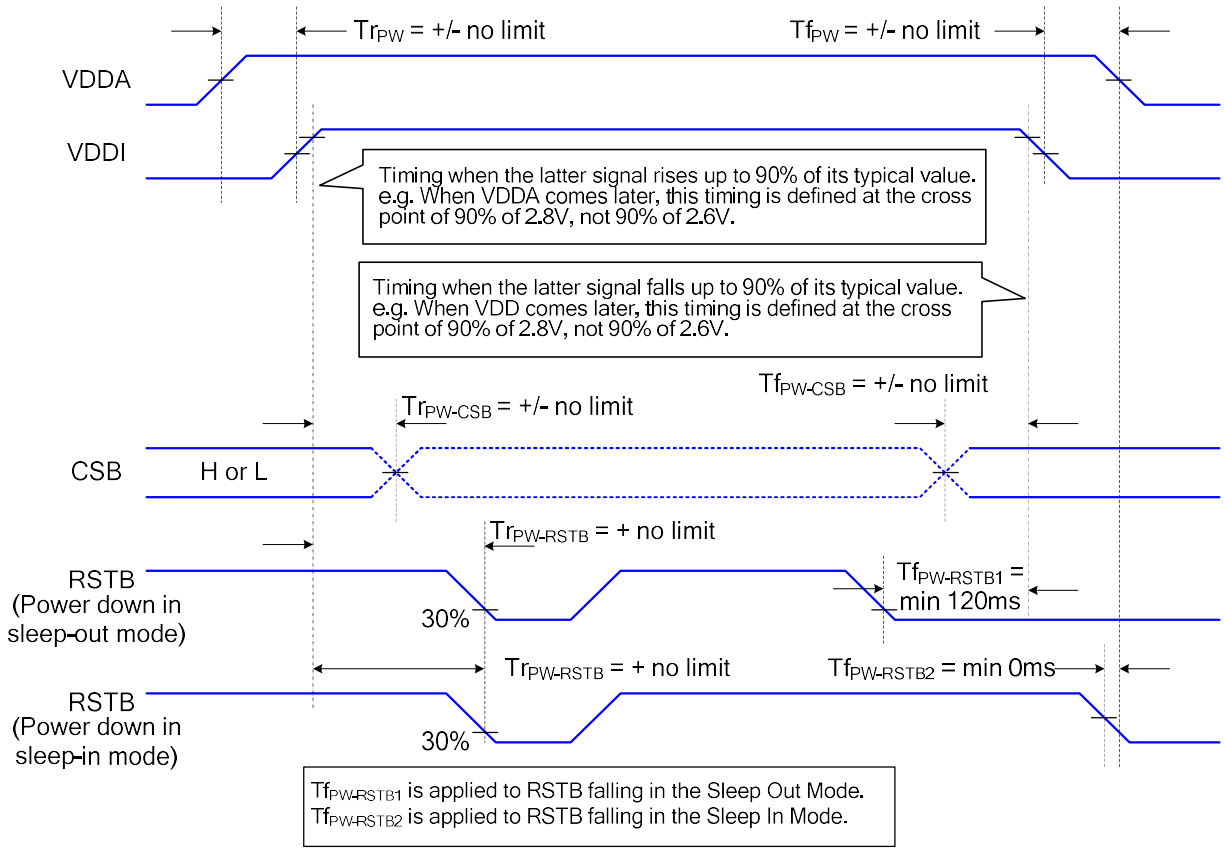
During power off, if LCD is in the Sleep Out mode, VDDA and VDDI must be powered down minimum 120msec after RSTB has been released.

During power off, if LCD is in the Sleep In mode, VDDI or VDDA can be powered down minimum 0msec after RSTB has been released.

CSB can be applied at any timing or can be permanently grounded. RSTB has priority over CSB.

Note 1: There will be no damage to the display module if the power sequences are not met.
Note 2: There will be no abnormal visible effects on the display panel during the Power On/Off Sequences.
Note 3: There will be no abnormal visible effects on the display between end of Power On Sequence and before receiving Sleep Out command. Also between receiving Sleep In command and Power Off Sequence.
Note 4: If RSTB line is not held stable by host during Power On Sequence as defined in the sequence below, then it will be necessary to apply a Hardware Reset (RSTB) after Host Power On Sequence is complete to ensure correct operation. Otherwise function is not guaranteed.

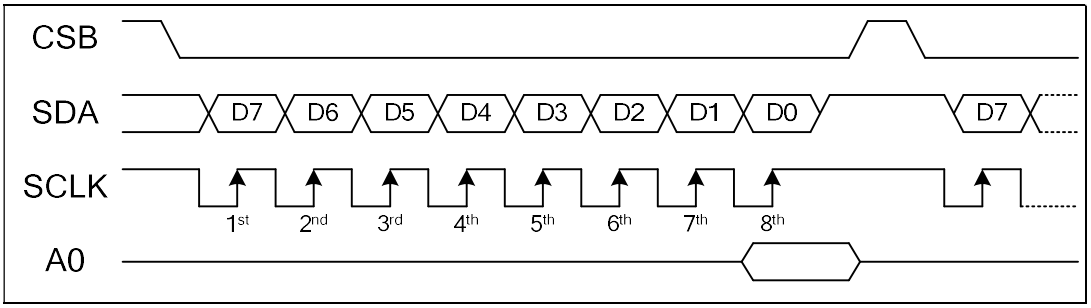
The power on/off sequence is illustrated below



7.1. Single 4-Line Serial Interface

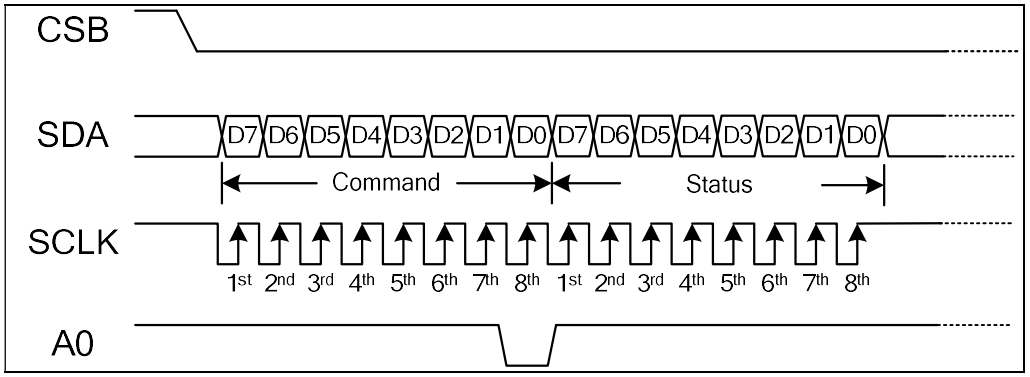
ST7306 is active when CSB is “L”, serial data (SDA) and serial clock (SCLK) inputs are enabled. When CSB is “H”, ST7306 is not active, the internal 8-bit shift register and 3-bit counter are reset. The DDRAM column address pointer will be increased by one automatically after writing each byte of DDRAM.

The display data/command indication is controlled by the register selection pin (A0). The signals transferred on data bus will be display data when A0 is high and will be instruction when A0 is low. Serial data (SDA) is latched at the rising edge of serial clock (SCLK). After the 8th serial clock, the serial data will be processed as 8-bit parallel data. The DDRAM column address pointer will be increased by one automatically after each byte of DDRAM access.



Write Operation of 4-Line SPI

After entering the “Read Status” instruction to read IC status, the information is shifted out as shown below. CSB signal must be kept at “L” during this period. All read out data will be 8 bits.



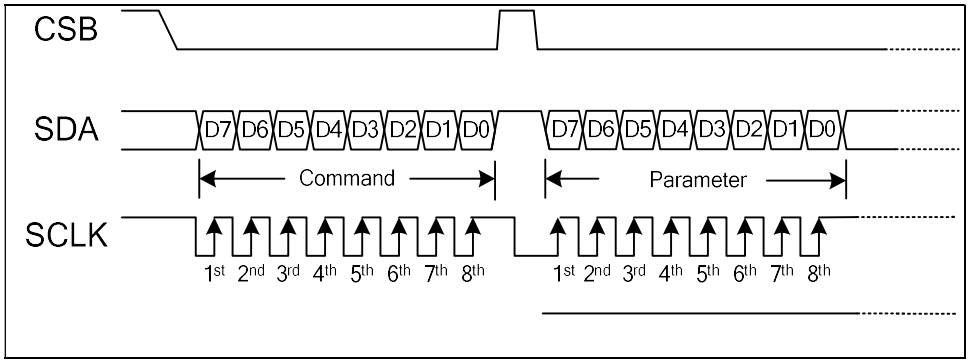
Read Status Operation of 4-Line SPI

7.2 Dual 4-Line Serial Interface

Dual 4-line serial interface use: CSB (chip enable), SCLK (serial clock), SDA (serial data input/output 1), RWR (serial data input 2) and A0.

Command write mode:

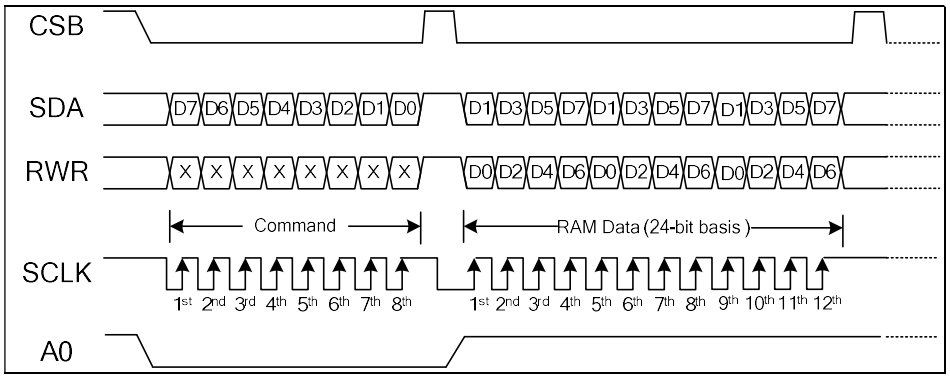
The command write protocol of dual 4-line serial interface is the same with the single 4-line serial interface. The display data/command indication is controlled by the register selection pin (A0). Any instruction can be sent in any order to the driver. The MSB is transmitted first. The serial interface is initialized when CSB is high. In this state, SCLK clock pulse or SDA data have no effect. A falling edge on CSB enables the serial interface and indicates the start of data transmission.



Command Write Operation of Dual 4-Line SPI

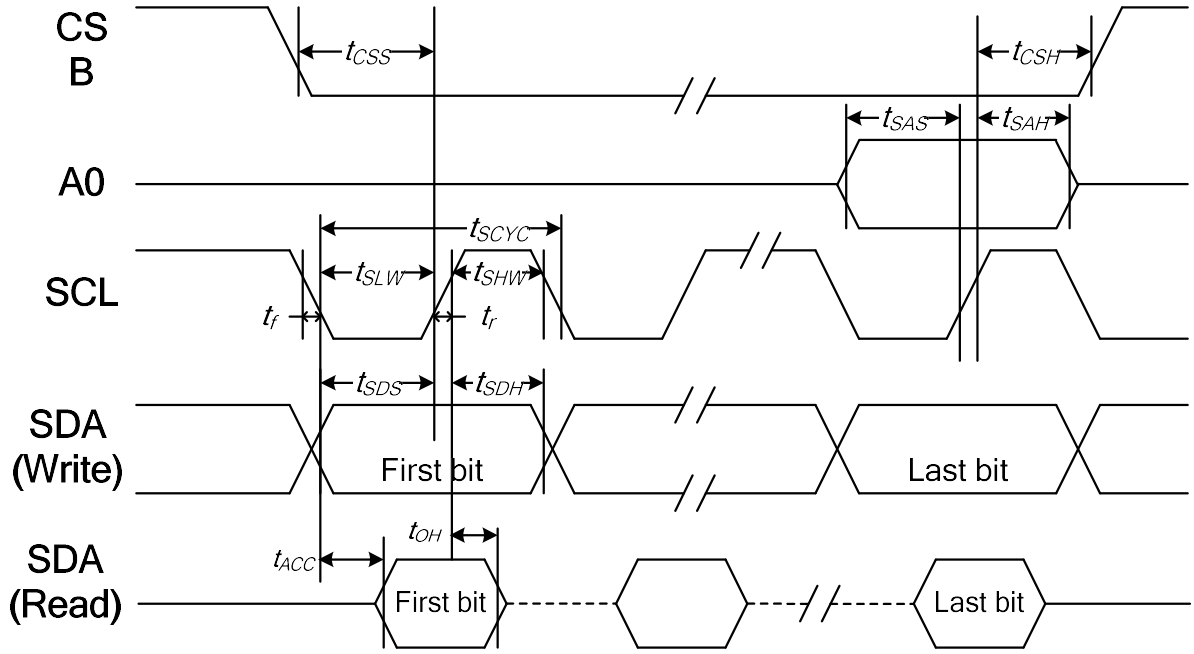
RAM write mode:

The RAM write mode of dual 4-line serial interface need use SDA pin and RWR pin to be data input pins. The LSB is transmitted first and the data bit will be exchanged between SDA and RWR.



RAM Write Operation of Dual 4-Line SPI

8.. System Bus Timing for 4SPI MCU Interface



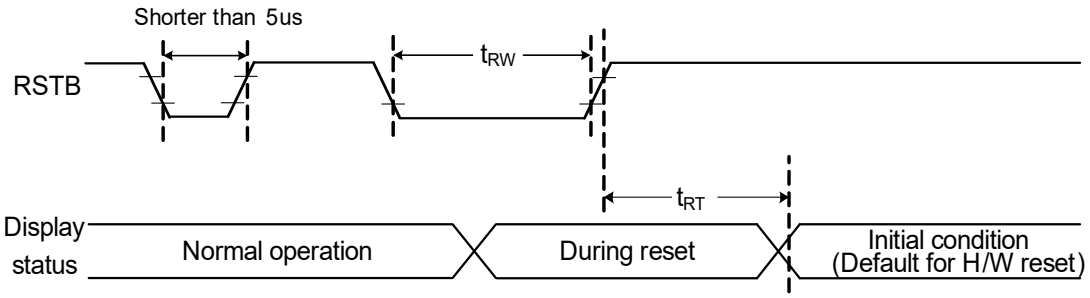
VDDI = 1.8~3.3V, Ta = 25°C

Item	Signal	Symbol	Condition	Min.	Max.	Unit
Serial clock period (Write)	SCL	tSCYC		30	—	ns
Serial clock period (Read)				150		
SCLK “H” pulse width (Write)		tSHW		15	—	
SCLK “H” pulse width (Read)				60		
SCLK “L” pulse width (Write)		tSLW		15	—	
SCLK “L” pulse width (Read)				60		
Address setup time	A0	tSAS		10	—	
Address hold time		tSAH		10	—	
Data setup time	SDA (Write)	tSDS		10	—	
Data hold time		tSDH		10	—	
Read data access time	SDA (Read)	tACC	For maximum CL=30p	10	50	
Read data output disable time		tOH	For minimum CL=8p	15	50	
CSB-SCLK time	CSB	tCSS		10	—	
CSB-SCLK time		tCSH		10	—	

Note:

1. The input signal rise and fall time (tr, tf) are specified at 15 ns or less.
2. All timing is specified using 20% and 80% of VDDI as the standard.

9. Reset Timing



VDDI = 1.8~3.3V, Ta = 25°C

Item	Symbol	Condition	Min.	Max.	Unit
Reset "L" pulse width	tRW		1	—	ms
Reset cancel	tRT	Note1, 5 (sleep-in mode)	—	5	ms
		Note1, 6, 7 (sleep-out mode)	—	120	ms

Notes:

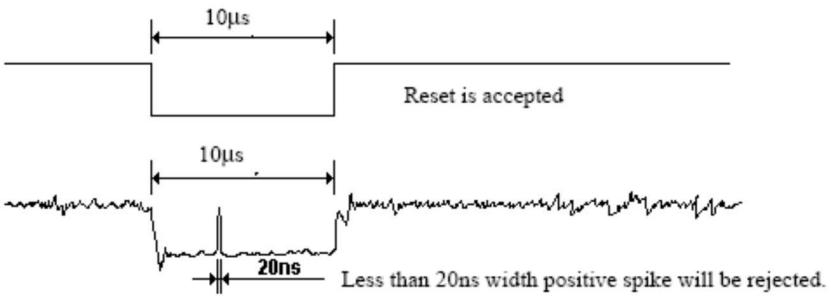
1. The reset cancel includes also required time for loading ID bytes, VSource setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RSTB.

2. Spike due to an electrostatic discharge on RSTB line does not cause irregular system reset according to the table below:

RSTB Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.

4. Spike Rejection also applies during a valid reset pulse as shown below:



10.0 OPTICAL CHARACTERISTICS

10.1 Optical Specification

Item		Symbol	Condition	Min.	Typ.	Max.	Unit	Note
White Reflectance (with Polarizer)		Rw (%)	Θ=0 Normal viewing angle —	—	40	—	%	(4) Measuring with HSD polarizer， Reference Only Base on Vop=3.6V
Contrast Ratio		CR		—	15	—	—	(1)(2) Base on Vop=3.6V
Response Time		ms			10			
Color Chromaticity (CIE1931)	White	W_x		—	0.300	—	—	(1)(4) Measuring with HSD polarizer， Reference Only
		W_y		—	0.330	—		
Viewing Angle	Hor.	Θ_L	CR>2	—	60	—		(1)(4) Measuring with HSD polarizer， Reference Only
		Θ_R		—	60	—		
	Ver.	Θ_U			60			
		Θ_D			60			

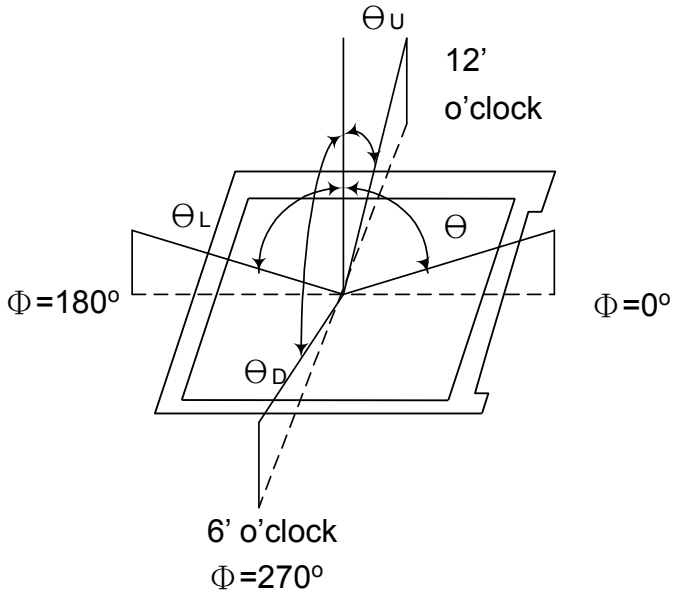
10.2 Measuring Condition

- Measuring surrounding dark room
- Ambient temperature 25±2°C
- 15min. warm-up time.

10.3 Measuring Equipment

- DMS (DMS = Display Measurement System) of AUTRONIC-MELCHERS GmbH, motorized goniometer system for comprehensive display characterization

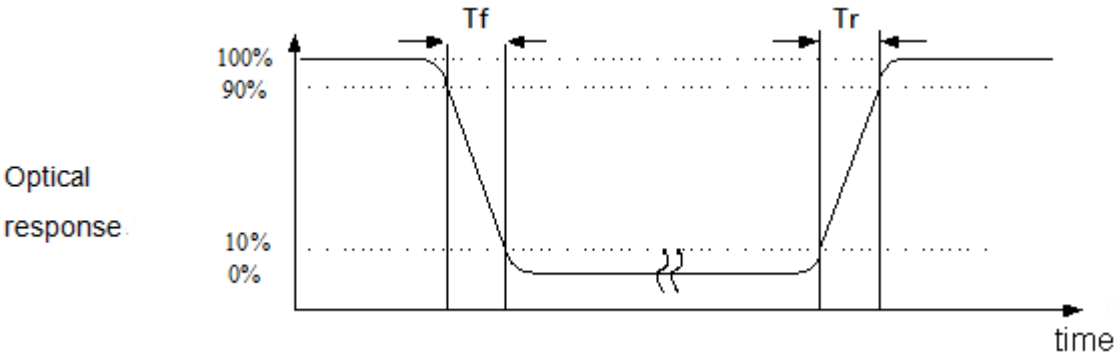
Note (1) Definition of Viewing Angle:



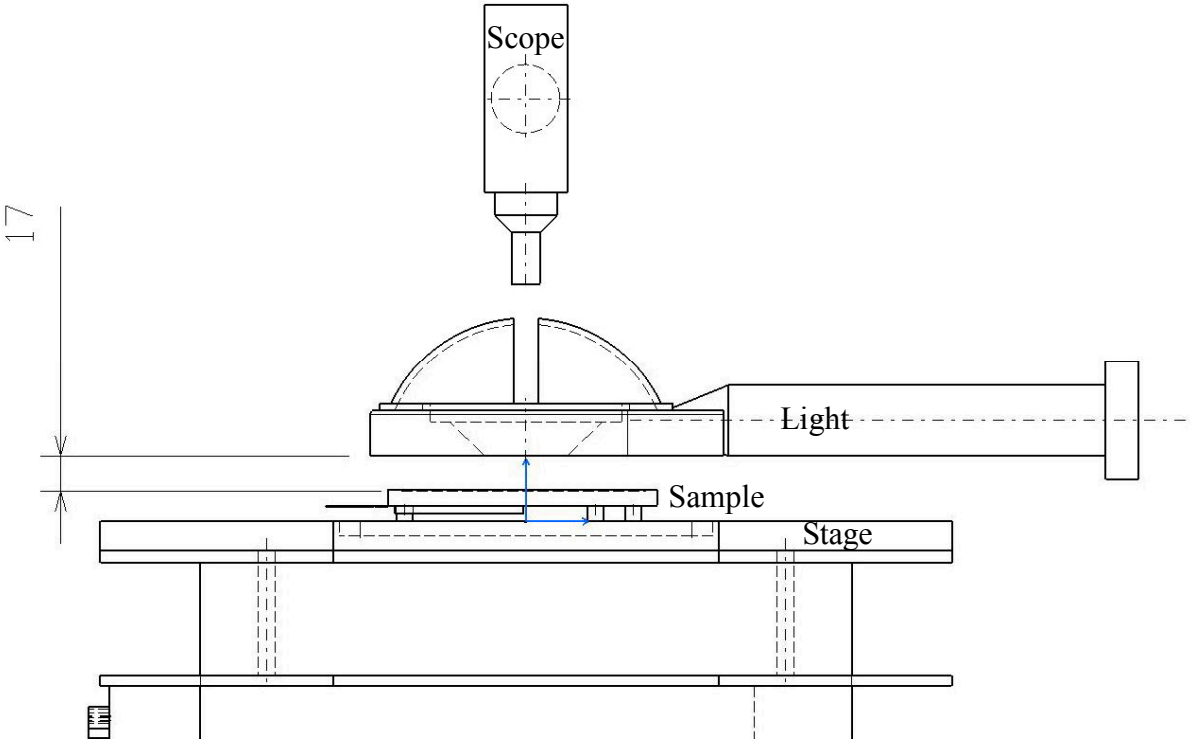
Note (2) Definition of Contrast Ratio (CR) :
measured at the center point of panel

$$CR = \frac{\text{Luminance with all pixels white}}{\text{Luminance with all pixels black}}$$

Note (3) Definition of Response Time : Sum of T_R and T_F



Note (4) Definition of optical measurement setup



10.4 Reliability test items

No.	Test Item	Test Condition	Notes
1	High Temp. Storage	+80°C / 48H	1. Functional test isOK. Missing Segment,short, unclear segment non-display,display abnormally and liquid crystal leakare un-allowed. 2. No low temperature bubbles,end seal loose andfall, frame rainbow.
2	Low Temp. Storage	-30°C / 48H	
3	High Tempe. Operating	+70°C / 48H	
4	Low Tempe. Operating	-20°C / 48H	
5	High Temperature /Humidity storage	50°C x 90%RH /48H	
6	Thermal and cold shock	Static state， -20℃（30min） ~60℃（30min），50 cycles	
7	ESD test	± 2KV,Human Body Mode, 150pF/330Ω; ±4KV, Air Mode, 150pF/330Ω;	

Note: All tests above are practiced at module type.

There is no display function NG issue occurred, All the cosmetic specification is judged before the reliability stress.

11.0 General Precaution

11.1 Use Restriction

This product is not authorized for use in life supporting systems, aircraft navigation control systems, military systems and any other application where performance failure could be life-threatening or otherwise catastrophic.

11.2 Asembly Precaytton

1、Please use the mounting hole on the module side in installing and do not bending or wrenching LCD in assembling. And please do not drop, bend or twist LCD module in handling.

2、Please design display housing in accordance with the following guide lines.

3、Housing case must be destined carefully so as not to put stresses on LCD all sides and not to wrench module. The stresses may cause non-uniformity even if there is no non-uniformity statically.

4、Keep sufficient clearance between LCD module back surface and housing when the LCD module is mounted. The clearance in the design is recommended taking into account the tolerance of LCD module thickness and mounting structure height on the housing.

5、 Please do not push or scratch LCD panel surface with any-thing hard. And do not soil LCD panel surface by touching with bare hands. (Polarizer film, surface of LCD panel is easy to be flawed.)

6、Please do not press any parts on the rear side such as source IC, gate IC, and FPC during handling LCD module. If pressing rear part is unavoidable, handle the LCD module with care not to damage them.

7、Please wipe out LCD panel surface with absorbent cotton or soft cloth in case of it being soiled.

8、 Please wipe out drops of adhesives like saliva and water on LCD panel surface immediately. They might damage to cause panel surface variation and color change. 11.2.7 Please do not take a LCD module to pieces and reconstruct it. Resolving and reconstructing modules may cause them not to work well.

11.3 Disassembling or Modification

Do not disassemble or modify the module. It may damage sensitive parts inside LCD module, and may cause scratches or dust on the display. Leadtek does not warrant the module, if customers disassemble or modify the module.

11.4 Breakage of LCD Panel

1 、If LCD panel is broken and liquid crystal spills out, do not ingest or inhale liquid crystal, and do not contact liquid crystal with skin.

2、 If liquid crystal contacts mouth or eyes, rinse out with water immediately.

3、 If liquid crystal contacts skin or cloths, wash it off immediately with alcohol and rinse thoroughly with water.

4、 Handle carefully with chips of glass that may cause injury, when the glass is broken.

11.5 Absolute Maximum Ratings and Power Protection Circuit

1、Do not exceed the absolute maximum rating values, such as the supply voltage variation, input voltage variation, variation in parts' parameters, environmental temperature, etc., otherwise LCD module may be damaged.

2、 Please do not leave LCD module in the environment of high humidity and high temperature for a long time.

3、 It's recommended employing protection circuit for power supply.

11.6 Operation

1、Do not touch, push or rub the polarizer with anything harder than HB pencil lead.Use fingerstalls of soft gloves in order to keep clean display quality, when persons handle the LCD module for incoming inspection or assembly.

2、 When the surface is dusty, please wipe gently with absorbent cotton or other soft material.

3、Wipe off saliva or water drops as soon as possible. If saliva or water drops contact with polarizer for a long time, they may causes deformation or color fading.

4、When cleaning the adhesives, please use absorbent cotton wetted with a little petroleum benzine or other adequate solvent.

11.6 Static Electricity

1、Protection film must remove very slowly from the surface of LCD module to prevent from electrostatic occurrence.

2、 Because LCD module uses CMOS-IC on TFT-LCD panel, it is very weak to electrostatic discharge. Please be careful with electrostatic discharge.

3、Persons who handle the module should be grounded through adequate methods.

11.7 Disposal

When disposing LCD module, obey the local environmental regulations.

11.8 OTHERS

1、A strong incident light into LCD panel might cause display characteristics' changing inferior because of polarizer film, color filter, and other materials becoming inferior. Please do not expose LCD module direct sunlight land strong UV rays.

2、 Please pay attention to a panel side of LCD module not to contact with other materials in preserving it alone.

3、 For the packaging box, please pay attention to the followings:

4、Packaging box and inner case for LCD are designed to protect the LCDs from the damage or scratching during transportation. Please do not open except picking LCDs up from the box.

5、 Please do not pile them up more than 6 boxes. (They are not designed so.) And please do not turn over.

6、 Please handle packaging box with care not to give them sudden shock and vibrations. And also please do not throw them up.

7、Packing box and inner case for LCDs are made of cardboard. So please pay attention not to get them wet. (Such like keeping them in high humidity or wet place can occur getting them wet.)

12.0 Packing form-TBD

深圳市丽台电子有限公司

Shenzhen Leadtek Electronics Co.,Ltd

Quality Inspection Standards

品质允收标准

Model No. / 产品型号: **Applies 0.95~5.0 Inch Touch Display Screen**
Updated Date /生效日期: **2022-05-20**
Version / 版 本: **A0**
Customer confirmation : _____

Record of Revision /修订履历

Version /版本	Revision Record /修订内容	Reviser /修订人	Revision Date /修订日期
V0	首发 / Starting	Green	2022.05.20

1.Scope of application /适用范围.

This document shall be applied to 0.95~5.0 inch touch display screen.

本文件适用于0.95~5.0 寸触摸显示屏.

2.Inspection conditions and environment /检验条件与环境.

2. 1 Inspection Conditions /检验条件:

(1) Inspection Distance /检测距离: 35cm ±5cm.

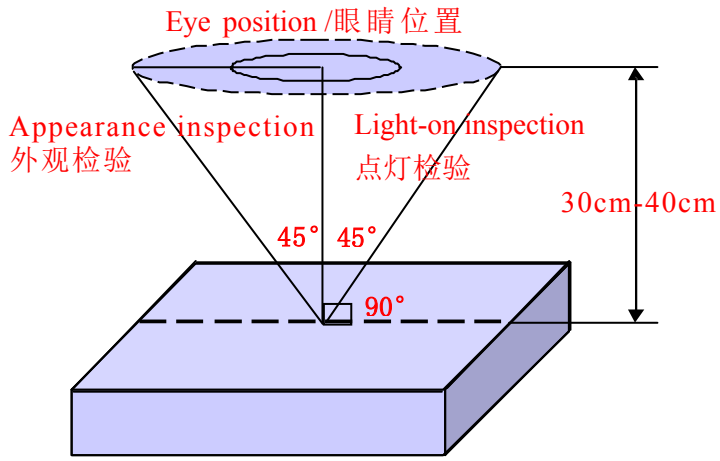
(2) Check time /检验时间：

Displays performance test /功能测试：2~3S /Image，Cosmetic Inspection /外观检验:10~12S.

(3) Check the viewing angle /检验视角:

Light-on Inspection Angle /点灯检验角度： ±45°.

Cosmetic Inspection Angle /外观检验角度：±45°.



(Perpendicular to LCD panel surface /垂直于LCD表面)

2.2 Inspection environment /检验环境:

Ambient Temperature 温度		25℃±5℃
Ambient Humidity 湿度		55±5%RH
Ambient Illumination 亮度	Cosmetic Inspection 外观检验	800-1000 Lux
	Functional Inspection 点灯检验	200~300Lux

2.3 Sampling Conditions /抽样条件:

（1）Quantity to be inspected /批量：Quantity of shipment lot per model /单次运送单一型号数量.

（2）Sampling method /抽样方法：

Sampling Plan /抽样计划		GB/T 2828.1- 2003
		Normal Inspection ， Single Sampling 正常检验、单次抽样
		General inspection level： Ⅱ 一般检验水平：二级
AQL	Major Defect /主要缺陷	0.65
	Minor Defect /次要缺陷	1.0

（3）The classification of Major(MA) and Minor(MI) defects is shown as “3.1 Classification of defects”.

主缺（MA）及次缺（MI）定义于”3.1缺陷分类”.

3.Terms And Definitions /术语和定义

3.1 Classification of defects / 缺陷分类 :

（1）Major defects /主要缺陷:

A major defect is a defect that is likely to result in failure, or to reduce materially the usability of the product for its intended purpose .

可导致产品功能失效或减少产品可用性的缺陷.

（2）Minor defects /次要缺陷:

It will not cause the product to fail and reduce the defects in the effective use and operation of the product.

不会导致产品功能失效和减少产品的有效使用与操作的缺陷.

3.2 Point defects /点状缺陷：

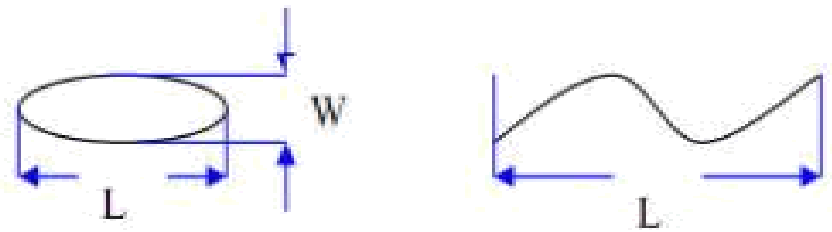
The size of the point defect is defined by the diameter D, and the average diameter of the defect is D=1/2（W+L）.

点状缺陷的大小是由直径 D 定义的，缺陷的平均直径 D=1/2(W+L).

3.3 Linear defects /线状缺陷：

When defect size L≥2W,the defect count as liner type defect.Size of linear defect is defined by length (L) and the maximum width (W).

当缺陷尺寸 L≥2W 时，被视为线状缺陷，线状缺陷是由长度 (L) 和最大宽度 (W) 定义的.



3.4 LCD sub-pixel dot /LCD子像素点

（1）Definition /定义： The point defect area is greater than 50% of the LCD sub-pixel area, and is visible through ND5% filter masking .

子像素点缺陷面积大于 50% LCD子像素面积, 且透过 ND5%遮盖是可见的.

（2）The drawing of 1/2 area sub-pixel definition / 1/2 面积的子像素定义绘图:

The 1/2 area sub-pixel can be defined as below one or more of specific shapes

1/2 面积的子像素可以定义为如下一个或多个特定形状图：

3.5 Small bright dot /细碎亮点：

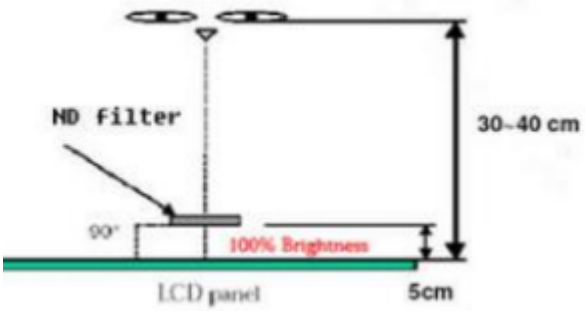
Point defects smaller than "LCD sub-pixels" /小于“LCD子像素点”的点缺陷.

（Ratio of Zone I to Zone O /I 区与 O 区比例：1：2：1）

3.6 ND filter inspection method /ND卡的检验方法：

Hold the ND filter about 5cm above the display area, with your eyes 30-40cm away from the panel, and observe for 2~3 seconds.

在显示区域上方大约 5cm 处握住 ND 卡，眼睛距离面板 30-40cm，观察2~3 秒.



3.7 Any FPC surface problems that do not leak copper on the surface and do not cause functional failure are acceptable.
任何 FPC 表面问题，表面未露铜和不造成功能失效是可以接受的.

3.8 Extraneous substances that can be wiped out， like Finger point,Particles are not considered as a defect .
可以被擦拭干净的表面物质不视为缺陷 (如手指印，尘粒) .

3.9 Defects that are covered by the material and are not visible to the eye and do not affect the function and use are not considered defects.

会被物料覆盖目视不可见，且不影响功能与使用的缺陷不视为缺陷.

3.10 Panel damage /面板损伤：

Glass damage outside the AA display area that does not affect the effective wiring is acceptable.

AA 显示区域以外的玻璃损伤，不影响有效线路是可以接受的.

3.11 Issues not specified or defined in this acceptance standard shall be handled through friendly negotiation between the two parties.

本允收标准中未规定或定义的问题，双方友好协商处理.

4. Inspection standards /检验标准

4.1 Structural Dimensions /结构尺寸规格

Serial Number 序号	Measurement items /测量项目		Specification /规格	Remark /备注
	名称 /Name	Unit /单位	Tolerance /公差	
1	Outside dimension：Length 尺寸：长	mm /毫米	0.10mm~0.20mm	Please refer to the product specification for detailed dimensions and tolerances 详细的尺寸规格和公差请参考产品规格书
2	Outside dimension：Width 尺寸：宽	mm /毫米	0.10mm~0.2mm	
3	Outside dimension：Thickness 尺寸：厚	mm /毫米	0.20mm~0.30mm	

4.2 Appearance Inspection Specification /外观检验规格

(D： diameter, W： width, L： length, N： quantity, DS： spacing)

Inspection area 检验区域	Inspection items 检验项目	Inspection specifications 检验规格	Defect category 缺陷类别	
Glass 玻璃	Wire(on Array) 线路	Can't be damaged 不能损伤	MA	
	Chipping/corner breaking 崩边/破角	Can't affect the effective lines and functions 不能影响有效线路和功能	MA	
	Edge 边缘	There must be no extensional cracks 不可有延伸性裂纹	MA	
Silicone 硅胶	Silicone coating 硅胶涂布	The height must not exceed the LCD CF surface 高度不能超过LCD CF面		MI
	Glue overflow 溢胶	Can't cover FPC, POL, etc 不能覆盖到FPC、POL等		MI

Inspection area 检验区域	Inspection items 检验项目	Inspection specifications 检验规格	Defect category 缺陷类别	
PCBA FPC Connector 连接器	Appearance 外观	Scratches or injuries are not allowed to cause copper exposure 划伤或损伤不允许表面出现露铜		MI
	Component 元器件	Can't be damaged and lack 不能损伤和缺少	MA	
	Gold finger oxidation 金手指氧化	Not allowed 不允许		MI
	Connection status 连接状况	The connection must be accurate and stable 必须准确稳定连接	MA	
	Break 破裂	Not allowed 不允许	MA	
	Soldering,: false soldering/tinning/tin beads 假焊/连锡/锡珠	Not allowed 不允许	MA	
POL 偏光片	Scratches 划伤	1. W≤0.05mm；L≤5mm，Ignore（忽略） 2. 0.05mm＜W≤0.10mm ; L≤5mm ; N≤3 ; DS≥10mm 3. 0.10mm＜W；5mm＜ L， Not allowable（不允许）		MI
	Dent 凹凸印	1. D≤0.15mm，Ignore（忽略） 2. 0.15mm＜D≤0.30mm；N≤3；DS≥10mm 3. 0.30mm＜D，Not allowable（不允许）		MI
	Bubbles 气泡	1. D≤0.15mm，Ignore（忽略） 2. 0.15mm＜D≤0.30mm；N≤3；DS≥10mm 3. 0.30mm＜D，Not allowable（不允许）		MI
	Point defects 点状不良	1. D≤0.15mm，Ignore（忽略） 2. 0.15mm＜D≤0.30mm；N≤3；DS≥10mm 3. 0.30mm＜D，Not allowable（不允许）		MI
	Edge bubbles 边缘气泡	1. Within 1/2BM of the display area, it is not allowed 显示区往外 1/2BM 区域内，不允许 2. The display area is 1/2 outside the BM area, and it is not controlled 显示区往外1/2BM区域以外，不管控		MI
	Dirty/watermarked 脏污/水印	No dirt/water lines/finger marks are allowed, and must be wiped clean 不允许有脏污/水印/手指印，须擦拭干净方可		MI
	Warping 起翘	Not allowed 不允许		MI
	Attaching offset 贴偏	It is necessary to completely cover the display area outward, within the 1/2BM area, or without leaking POL edges after TP is attached 需完整覆盖显示区往外、1/2BM区以内或贴合TP后不会出现漏偏光片边缘		MI
	Mixture 混料	Mixing different types of POL or not using POL as required by the BOM，not allowed 不允许混贴不同型号的POL或未按BOM要求使用POL	MA	

Inspection area 检验区域	Inspection items 检验项目	Inspection specifications 检验规格	Defect category 缺陷类别	
TP&CG	Point defects 点状不良	1. D≤0.15mm，Ignore（忽略） 2. 0.15mm＜D≤0.30mm；N≤3；DS≥10mm 3. 0.30mm＜D，Not allowable（不允许）		MI
	Scratches 划伤	1. W≤0.05mm；L≤5mm，Ignore（忽略） 2. 0.05mm＜W≤0.10mm ; L≤5mm ; N≤3 ; DS≥10mm 3. 0.10mm＜W；5mm＜ L， Not allowable（不允许） 4. There is a feeling scratch，Not allowable 有感划伤，不允许		MI
	Edges and corners cracked 崩角/崩边	1. Product front /产品正面： Edge and corner chipping is not allowed 崩角、崩边不允许 2. Product back /产品背面: X≤ 0.5 , Y≤0.5，Z≤1/2T；N≤3；DS≥10mm		MI
	Silk screen 丝印	The silk screen is clear, complete and correct 丝印清晰、完整、内容正确		MI
	Dirty 脏污	Non-wipeable dirt, not allowed 不可擦拭的脏污，不允许		MI
	Broken 破损	Not allowable 不允许	MA	
	Ink color aberration 油墨色差	ΔE>1，Not allowable（不允许）		MI
	Cover pinholes 针孔	1. D≤0.10mm , N≤3 , DS≥10mm，allowable 2. D＞0.10mm，intensive pinholes（密集型针孔），Not allowable（不允许）		MI
	IR holes IR孔	Dirt, deviation, color difference, etc. are not allowed 不允许脏污、偏位、色差等		MI
BL 背光	Backlight separation 背光分离	Not allowable 不允许		MI
	Deformation of rubber iron and rubber frame 胶铁、胶框变形	Use the plug gauge 0.3mm on the flat surface and can snap in and judge NG 在平面上使用塞规0.3mm卡翘曲位置，能卡进判定NG		MI
	The iron frame is oxidized and not tightened 铁框氧化、卡不紧	Not allowable 不允许		MI
	Backlight sticky solder beads, glue, etc 背面粘锡珠、残胶等	Not allowable 不允许		MI
	Lnkjet coding，Barcode，QR code 喷码/条码/二维码	The lnkjet coding is clear and complete, the barcode and QR code can be scanned normally, and the content and format match 喷码清晰完整、条码和二维码可正常扫描，内容和格式相符		MI
	Accessories (protective film, double-sided tape, insulating adhesive, etc.) 辅料（保护膜、双面胶、绝缘胶等）	Defects such as missing pastes, sticking deviations, defects, and fractures are not allowed 不允许有漏贴、贴偏、残缺、断裂等缺陷		MI

4.3 Electrical test specifications /电性检查规格

(D： diameter, W： width, L： length, N： quantity, DS： spacing)

Inspection items 检验项目	Inspection specifications 检验规格	Defect category 缺陷类别	
Glass bright spots/dark spots 玻璃亮点/暗点	1. D≤0.15mm，Ignore（忽略） 2. 0.15mm＜D≤0.30mm；N≤3；DS≥10mm 3. 0.30mm＜D，Not allowable（不允许）		MI
Mura	Use ND5% filter masking, visual invisibility is OK, 200~300Lux 使用ND5%遮盖，目视不可见即为OK，200~300Lux		MI
Small bright dot 细碎亮点	Use ND5% filter masking, visual invisibility is OK 使用ND5%遮盖，目视不可见即为OK		MI
Light leakage 漏光	1. Use ND5% filter masking, visual invisibility is OK 使用ND5%遮盖，目视不可见即为OK 2. If necessary, sign off on the sample 必要时，签限定样		MI
Backlight black/white dots 背光黑点/白点	1. D≤0.15mm，Ignore（忽略） 2. 0.15mm＜D≤0.30mm；N≤3；DS≥10mm 3. 0.30mm＜D，Not allowable（不允许）		MI
Linear foreign bodies 线状异物（异物毛丝等）	1. W≤0.05mm；L≤5mm，Ignore（忽略） 2. 0.05mm＜W≤0.10mm ; L≤5mm ; N≤3 ; DS≥10mm 3. 0.10mm＜W；5mm＜ L， Not allowable（不允许）		MI
Black/White Print 黑印/白印	Use ND5% filter masking, visual invisibility is OK 使用ND5%遮盖，目视不可见即为OK		MI
The display is uneven 显示不均匀	Use ND5% filter masking, visual invisibility is OK 使用ND5%遮盖，目视不可见即为OK		MI
The brightness is uneven 亮度不均匀	Brightness uniformity＜85.0%，Not allowable 亮度均匀性＜85.0%，不允许		MI
Displacement of the membrane 膜材移位	Not allowable 不允许		MI
Interference pattern/Newtonian pattern 干涉纹/牛顿纹	Not allowable 不允许		MI
Display abnormal 显示异常	Not allowable 不允许	MA	
No display 无显示	Not allowable 不允许	MA	
Line/Missing Drawing 线条/缺画	Not allowable 不允许	MA	
Splash screen 闪屏	Not allowable 不允许	MA	
LCD grid LCD网格	Not allowable 不允许	MA	
Afterimage 残影	Not allowable 不允许	MA	
Wrong viewing angle 视角错误	Not allowable 不允许	MA	
No touch 无触摸	Not allowable 不允许	MA	
Touch the jump point 触摸跳点	Not allowable 不允许	MA	
Not sensitive 触摸不灵敏	Not allowable 不允许	MA	